

NCS2554

Four-Channel Video Driver with SD Reconstruction Filters

The NCS2554 is a 4-channel high speed video driver with 6th order Butterworth Reconstruction filters on each channel. A first set of 3-channel has Standard Definition (SD) filters, one per channel. A fourth channel offers an extra filter driver for driving Cvbs-type video signal. The NCS2554 is in fact a combination of a triple SD video driver for YPbPr plus a single Cvbs video driver.

It is designed to be compatible with Digital-to-Analog Converters (DAC) embedded in most video processors.

To further reduce power consumption, 2 enable pins are provided one for the triple driver and another one for the single driver. All channels can accept DC- or AC-coupled signals. In case of AC-coupled inputs, the internal clamps are enabled. The outputs can drive both AC and DC coupled 150 Ω loads.

Features

- 4-Channel with per Channel a Selectable Sixth-Order Butterworth 8 MHz Filter
- Transparent Clamp
- Internal Fixed Gain: 6 dB $\pm$ 0.2
- Integrated Level Shifter
- AC- or DC-Coupled Inputs and Outputs
- Low Quiescent Current
- Shutdown Current 42 μ A Typical (Disabled)
- Each channel Capable to Drive 2 by 150 Ω Loads
- Wide Operating Supply Voltage Range: +4.7 V to +5.3 V
- Robust ESD protection 8 kV
- TSSOP-14 Package
- This is a Pb-Free Device

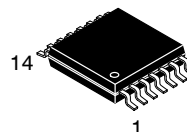
Typical Application

- Set Top Box Decoder
- DVD Player / Recorder
- SDTV



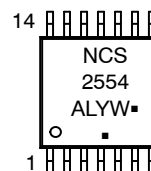
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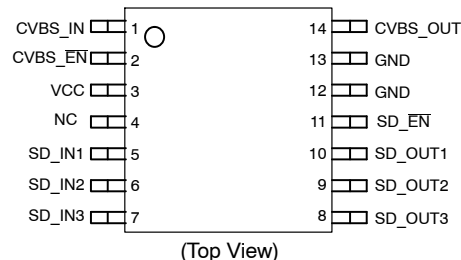
TSSOP-14
TBD SUFFIX
CASE 948G

MARKING DIAGRAM



NCS2554 = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

PINOUT



ORDERING INFORMATION

Device	Package	Shipping†
NCS2554DTBR2G	TSSOP-14 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NCS2554

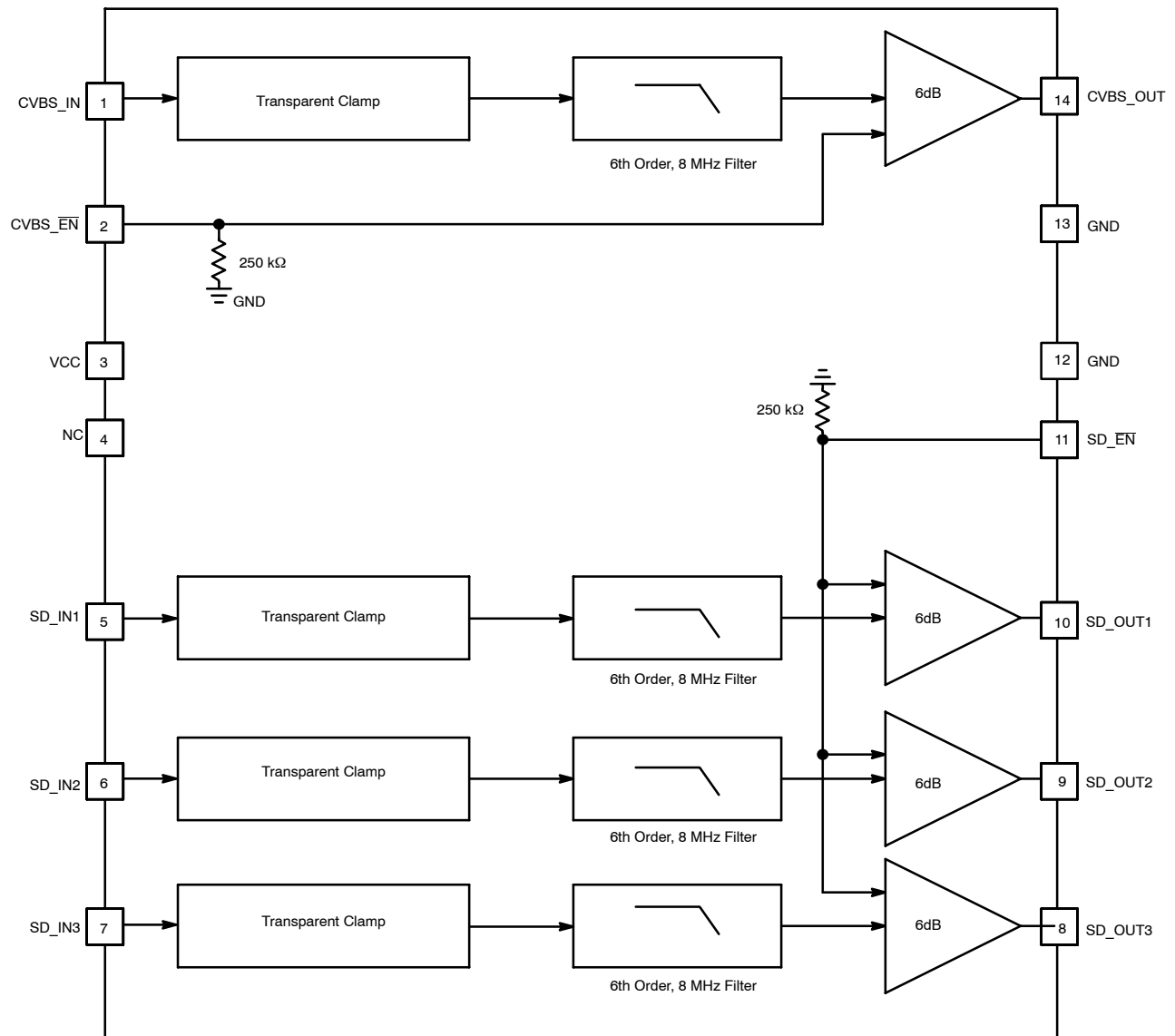


Figure 1. NCS2554 Block Diagram

NCS2554

PIN DESCRIPTION

Pin No.	Name	Type	Description
1	CVBS_IN	Input	Video Input for Video Signal featuring a frequency bandwidth compatible with NTSC / PAL / SECAM Video (8 MHz) – Cvbs Channel
2	CVBS_EN	Input	Cvbs Channel Enable /Disable Function: Low = Enable, High = Disable. When left open the default state is Enable.
3	VCC	Power	Power Supply / 4.7 V to 5.3 V
4	NC	Input	Not Connected
5	SD_IN1	Input	Selectable SD Video Input 1 – SD Channel 1
6	SD_IN2	Input	Selectable SD Video Input 2 – SD Channel 2
7	SD_IN3	Input	Selectable SD Video Input 3 – SD Channel 3
8	SD_OUT3	Output	SD Video Output 3 – SD Channel 3
9	SD_OUT2	Output	SD Video Output 2 – SD Channel 2
10	SD_OUT1	Output	SD Video Output 1 – SD Channel 1
11	SD_EN	Input	SD Channel Enable/Disable Function: Low = Enable, High = Disable. When left open the default state is Enable.
12	GND	Ground	Ground
13	GND	Ground	Ground
14	CVBS_OUT	Output	Cvbs Video Output – Cvbs Channel

ATTRIBUTES

Characteristic	Value
Moisture Sensitivity (Note 1)	Level 1
Flammability Rating	Oxygen Index: 28 to 34 UL 94 V-0 @ 0.125 in.

1. For additional information, see Application Note AND8003/D

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Power Supply Voltages	V_{CC}	$-0.3 \leq V_{CC} \leq 5.5$	Vdc
Input Voltage Range	V_I	$-0.3 \leq V_I \leq V_{CC}$	Vdc
Input Differential Voltage Range	V_{ID}	$-0.3 \leq V_I \leq V_{CC}$	Vdc
Output Current (Indefinitely) per Channel	I_O	40	mA
Maximum Junction Temperature (Note 2)	T_J	150	°C
Operating Ambient Temperature	T_A	-40 to +85	°C
Storage Temperature Range	T_{stg}	-60 to +150	°C
Thermal Resistance, Junction-to-Air	$R_{\theta JA}$	125	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

2. Power dissipation must be considered to ensure maximum junction temperature (T_J) is not exceeded.

Maximum Power Dissipation

The maximum power that can be safely dissipated is limited by the associated rise in junction temperature. For the plastic packages, the maximum safe junction temperature is 150°C. If the maximum is exceeded momentarily, proper circuit operation will be restored as soon as the die temperature is reduced. Leaving the device in the “overheated” condition for an extended period can result in device burnout. To ensure proper operation, it is important to observe the derating curves.

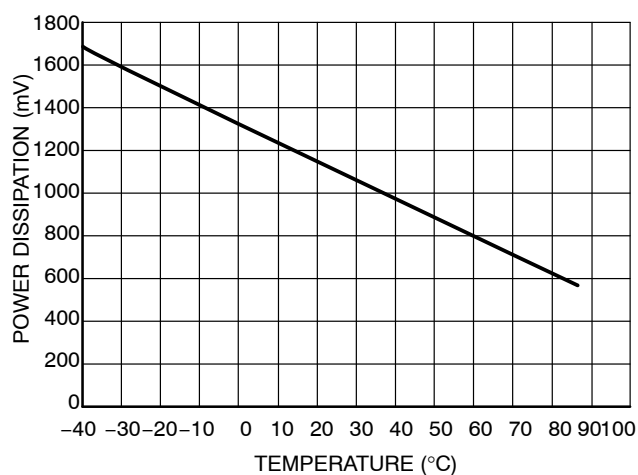


Figure 2. Power Dissipation vs Temperature

NCS2554

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = +5.0\text{ V}$, $R_{source} = 37.5\ \Omega$, $T_A = 25^\circ\text{C}$, inputs AC-coupled with $0.1\ \mu\text{F}$, all outputs AC-coupled with $220\ \mu\text{F}$ into $150\ \Omega$ referenced to $400\ \text{kHz}$; unless otherwise specified)

Symbol	Characteristics	Conditions	Min	Typ	Max	Unit
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POWER SUPPLY

V_{CC}	Supply Voltage Range		4.7	5.0	5.3	V
I_{CC}	Supply Current	SD Channels Selected + C_{VBS}		40	55	mA
I_{SD}	Shutdown Current ($CVBS_EN$ and SD_EN High)			42	60	μA

DC PERFORMANCE

V_i	Input Common Mode Voltage Range		GND		1.4	V_{PP}
V_{IL}	Input Low Level for the Control Pins (2, 11)		0		0.8	V
V_{IH}	Input High Level for the Control Pins (2, 11)		2.4		V_{CC}	V
R_{pd}	Pulldown Resistors on Pins $CVBS_EN$ and SD_EN			250		$k\Omega$

OUTPUT CHARACTERISTICS

V_{OH}	Output Voltage High Level			2.8		V
V_{OL}	Output Voltage Low Level			200		mV
I_O	Output Current			40		mA

AC ELECTRICAL CHARACTERISTICS FOR STANDARD DEFINITION CHANNELS (pin numbers (1, 14) (5, 10), (6, 9), (7, 8)) ($V_{CC} = +5.0\text{ V}$, $V_{in} = 1\text{ V}_{PP}$, $R_{source} = 37.5\ \Omega$, $T_A = 25^\circ\text{C}$, inputs AC-coupled with $0.1\ \mu\text{F}$, all outputs AC-coupled with $220\ \mu\text{F}$ into $150\ \Omega$ referenced to $400\ \text{kHz}$; unless otherwise specified)

Symbol	Characteristics	Conditions	Min	Typ	Max	Unit
A_{VSD}	Voltage Gain	$V_{in} = 1\text{ V}$ – All SD Channels	5.8	6.0	6.2	dB
BW_{SD}	Low Pass Filter Bandwidth (Note 4)	-1 dB -3 dB	5.5 6.5	7.2 8.0		MHz
A_{RSD}	Stop-band Attenuation (Notes 4 and 5)	@ 27 MHz	43	50		dB
dG_{SD}	Differential Gain Error			0.7		%
$d\Phi_{SD}$	Differential Phase Error			0.7		°
THD	Total Harmonic Distortion	$V_{out} = 1.4\text{ V}_{PP}$ @ 3.58 MHz		0.35		%
X_{SD}	Channel-to-Channel Crosstalk	@ 1 MHz and $V_{in} = 1.4\text{ V}_{PP}$		-57		dB
SNR_{SD}	Signal-to-Noise Ratio	NTC-7 Test Signal, 100 kHz to 4.2 MHz (Note 3)		72		dB
Δt_{SD}	Propagation Delay	@ 4.5 MHz		70		ns
ΔGD_{SD}	Group Delay Variation	100 kHz to 8 MHz		20		ns

3. $SNR = 20 \times \log(714\text{ mV} / \text{RMS noise})$

4. 100% of Tested ICs fit the bandwidth and attenuation tolerance at 25°C .

5. Guaranteed by characterization.

TYPICAL CHARACTERISTICS

$V_{CC} = +5.0\text{ V}$, $V_{in} = 1\text{ V}_{PP}$, $R_{source} = 37.5\ \Omega$, $T_A = 25^\circ\text{C}$, Inputs AC-coupled with $0.1\ \mu\text{F}$, All Outputs AC-coupled with $220\ \mu\text{F}$ into $150\ \Omega$
 Referenced to 400 kHz ; unless otherwise specified

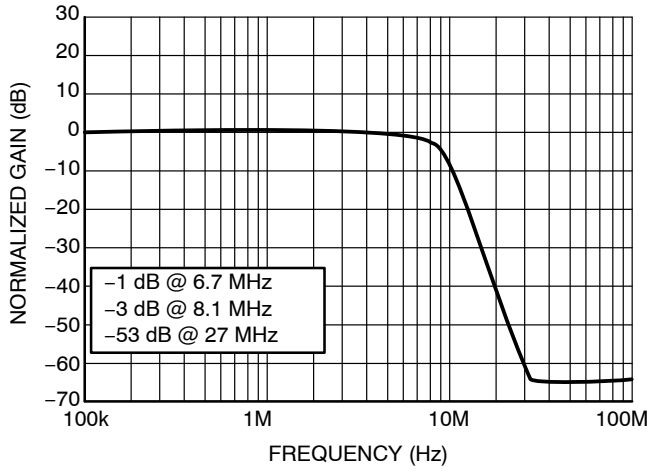


Figure 3. SD Normalized Frequency Response

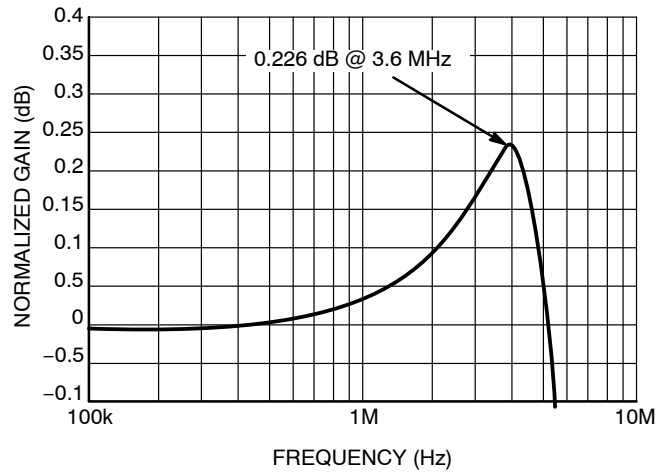


Figure 4. SD Passband Flatness

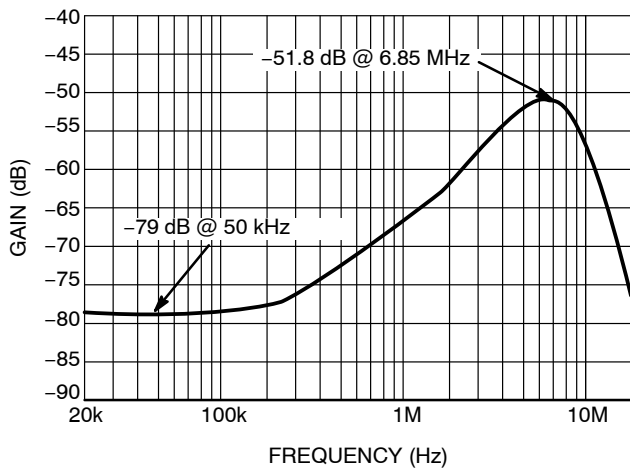


Figure 5. SD Channel-to-Channel Crosstalk

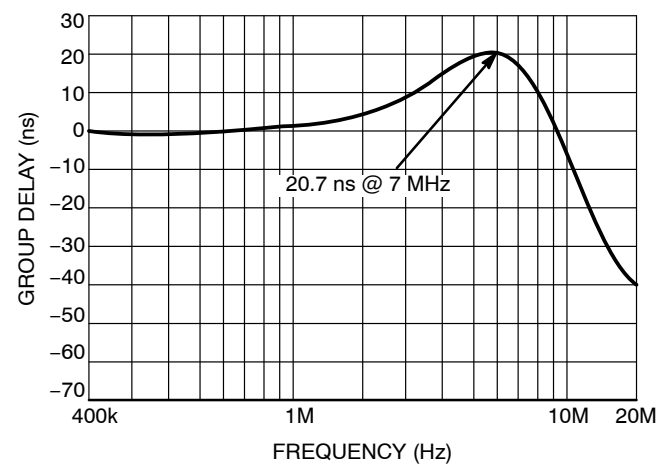


Figure 6. SD Normalized Group Delay

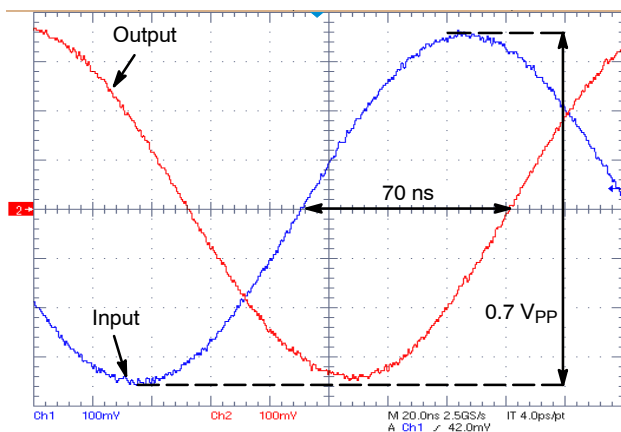


Figure 7. SD Propagation Delay

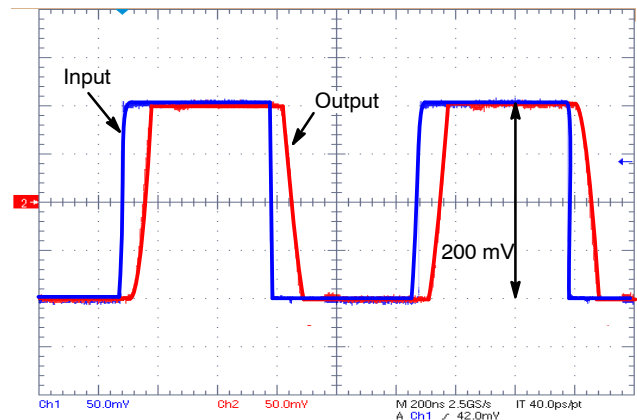


Figure 8. SD Small Signal Response

TYPICAL CHARACTERISTICS

$V_{CC} = +5.0\text{ V}$, $V_{in} = 1\text{ V}_{PP}$, $R_{source} = 37.5\ \Omega$, $T_A = 25^\circ\text{C}$, Inputs AC-coupled with $0.1\ \mu\text{F}$, All Outputs AC-coupled with $220\ \mu\text{F}$ into $150\ \Omega$
 Referenced to 400 kHz ; unless otherwise specified

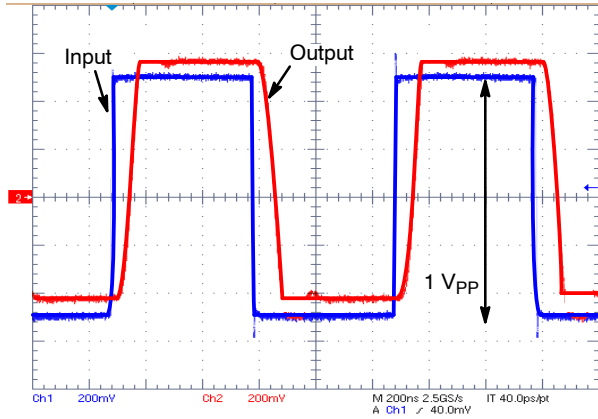


Figure 9. SD Large Signal Response

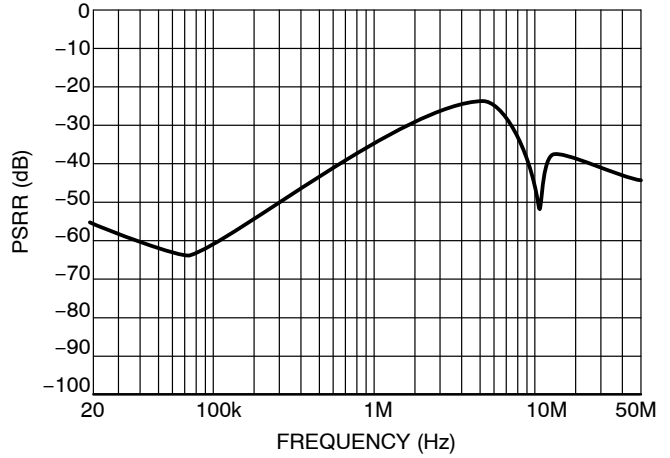


Figure 10. SD V_{CC} PSRR vs. Frequency

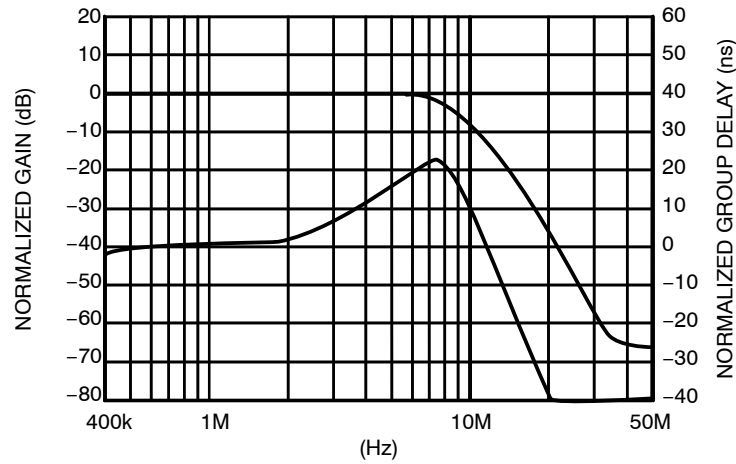


Figure 11. SD Frequency Response and Group Delay

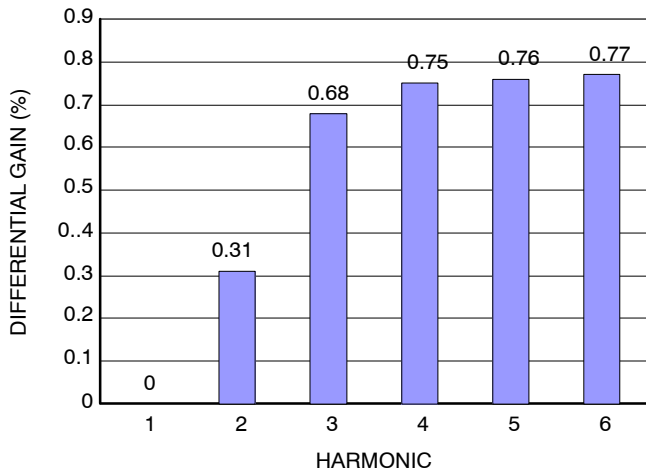


Figure 12. SD Differential Gain

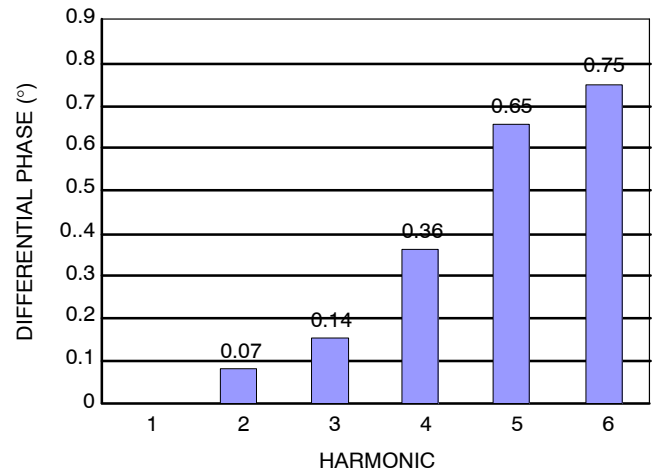


Figure 13. SD Differential Phase

APPLICATIONS INFORMATION

The NCS2554 quad video driver has been optimized for Standard video applications covering the requirements of the standards Composite video (CVbs), S-Video, Component Video (480i/525i, 576i/625i) and related (RGB). The three SD channels have 8 MHz filters for covering standard definition-like video applications.

In the regular mode of operation each channel provides an internal voltage-to-voltage gain of 2 from input to output. This effectively reduces the number of external components required as compared to discrete approached implemented with stand alone op amps. An internal level shifter is

employed shifting up the output voltage by adding an offset of 200 mV. This prevents sync pulse clipping and allows DC-coupled output to the 150 Ω video load. In addition, the NCS2554 integrates a 6th order Butterworth filter for each. This allows rejection of the aliases or unwanted over-sampling effects produced by the video DAC. Similarly for the case of DVD recorders which use an ADC, this anti-aliasing filter (reconstruction filter) will avoid picture quality issue and will aide filtration of parasitic signals caused by EMI interference.

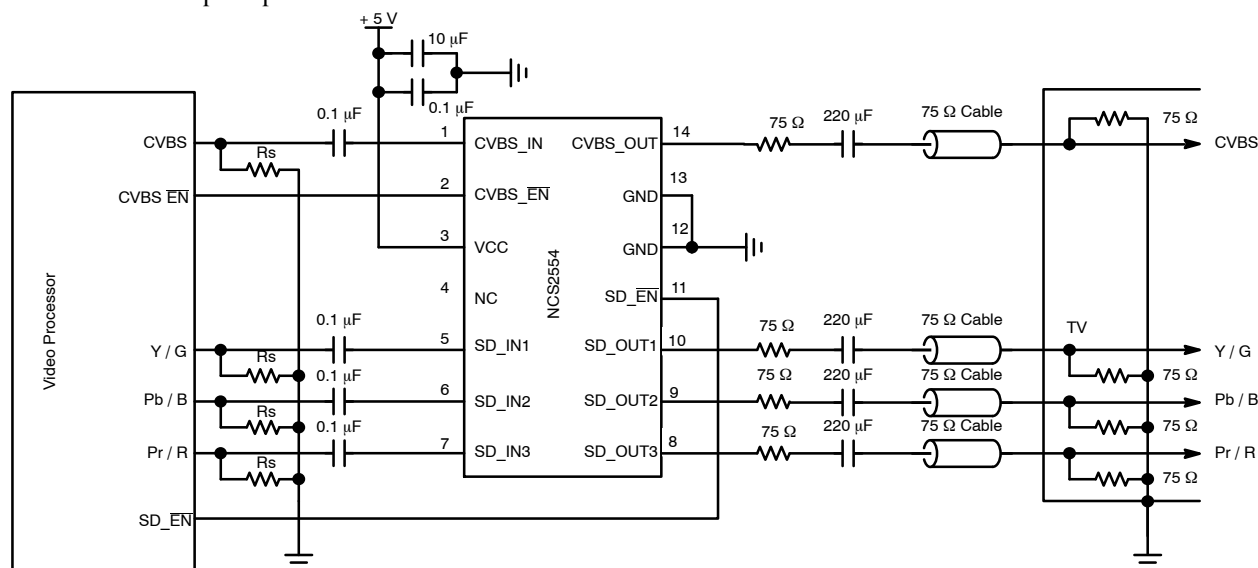


Figure 14. AC-Coupled Configuration at the Input and Output

A built-in diode-like clamp is used into the chip for each channel to support the AC-coupled mode of operation. The clamp is active when the input signal goes below 0 V.

The built-in clamp and level shifter allow the device to operate in different configuration modes depending on the DAC output signal level and the input common mode voltage of the video driver. When the configuration is DC-Coupled at the Inputs and Outputs the 0.1 μ F and 220 μ F coupling capacitors are no longer used, and the clamps are in that case inactive; this configuration provides a low cost solution which can be implemented with few external components (Figure 15).

The input is AC-coupled when either the input-signal amplitude goes over the range 0 V to 1.4 V or the video source requires such a coupling. In some circumstances it may be necessary to auto-bias signals with the addition of a pullup and pulldown resistors or only pullup resistor (Typical 7.5 M Ω combined with the internal 800 k Ω pulldown) making the clamp inactive.

The output AC-coupling configuration is advantageous for eliminating DC ground loop with the drawback of making the device more sensitive to video line or field tilt issues in the case of a too low output coupling capacitor. In

some cases it may be necessary to increase the nominal 220 μ F capacitor value.

Shutdown Mode

If the enable pins are left open by default the circuit will be enabled. The Enable pin offers a shutdown function, so the NCS2554 can consequently be disabled when not used. The NCS2554's quiescent current reduces to 42 μ A typical during shutdown mode.

DC-Coupled Output

The outputs of the NCS2554 can be DC-coupled to a 150 Ω load (Figure 15). This has the advantage of eliminating the AC-coupling capacitors at the output by reducing the number of external components and saving space on the board. This can be a key advantage for some applications with limited space.

The problems of field tilt effects on the video signal are also eliminated providing the best video quality with optimal dynamic or peak-to-peak amplitude of the video signal allowing operating thanks to the built-in level shifter without risk of signal clipping. In this coupling configuration the average output voltage is higher than 0 V and the power consumption can be a little higher than with an AC-coupled configuration.

NCS2554

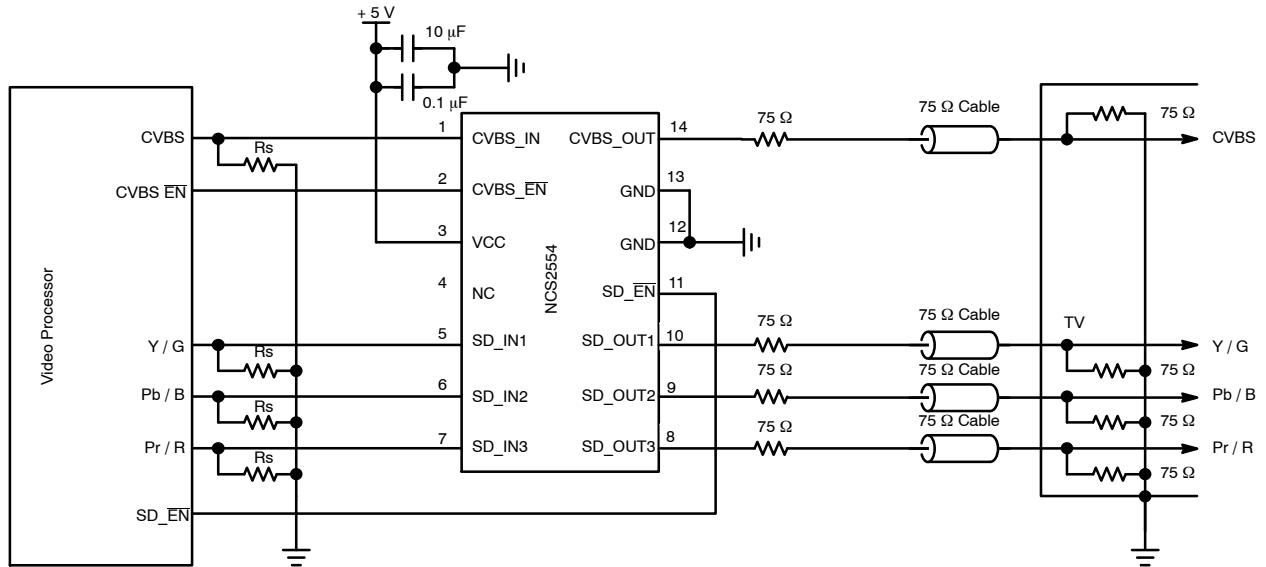


Figure 15. DC-Coupled Input and Output Configuration

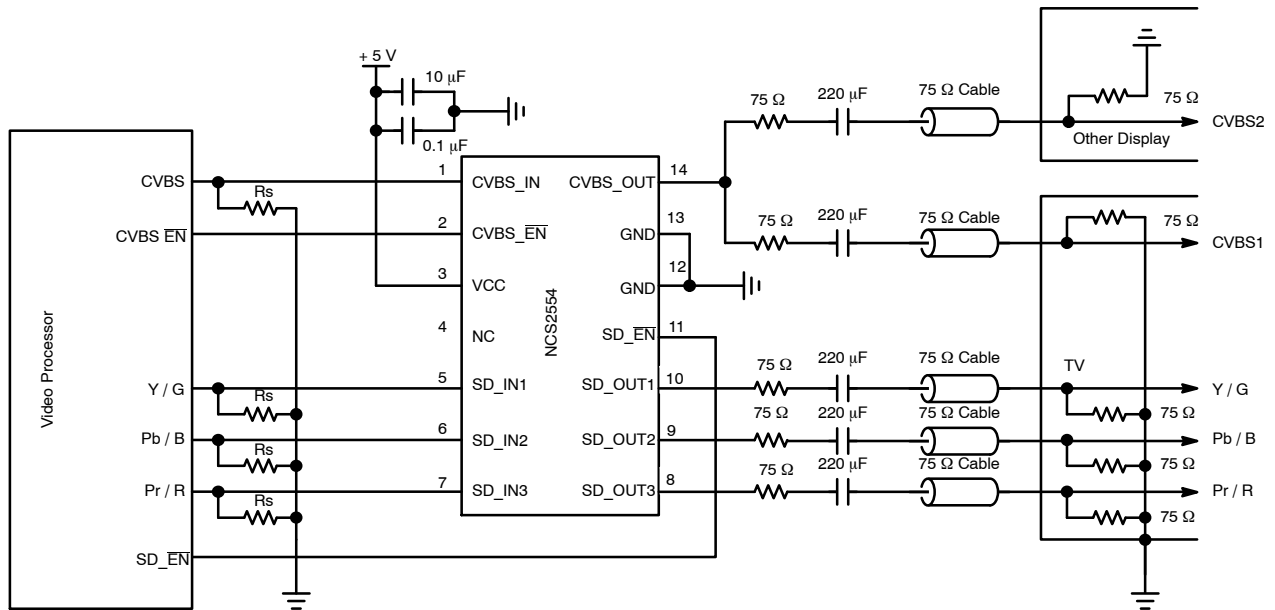


Figure 16. Typical Application

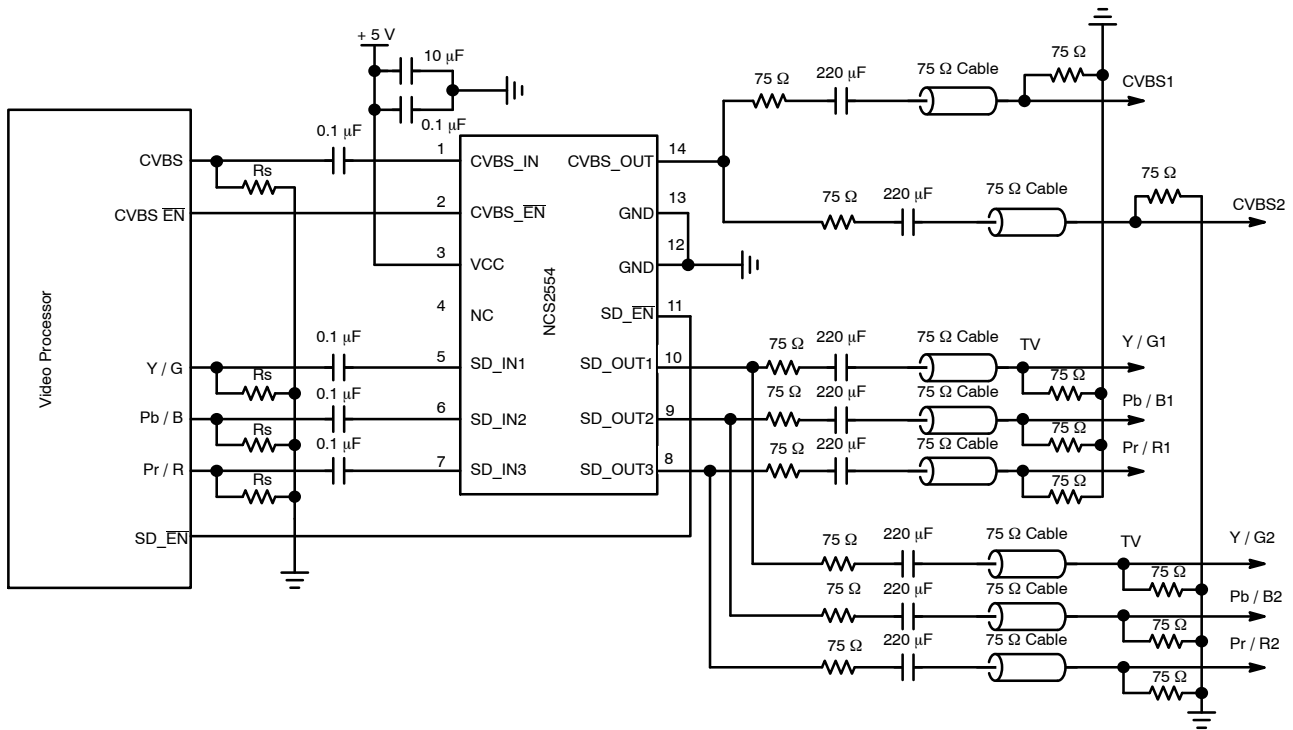


Figure 17. NCS2554 Driving 2 SCARTS Simultaneously

Video Driving Capability

With an output current capability of 40 mA the NCS2554 was designed to be able to drive at least 2 video display loads in parallel. This type of application is illustrated Figure 16. Figure 18 (multiburst) and Figure 19 (linearity) show that the video signal can efficiently drive a 75 Ω equivalent load and not degrade the video performance.

ESD Protection

All the device pins are protected against electrostatic discharge at a level of 8 kV. This feature has been considered

with a particular attention with ESD structure able to sustain a typical value of 8 kV. This parameter is particularly important for video drivers which usually constitute the last stage in the video chain before the video output connector. The test method used follow the IEC61000-4-2 methodology. More details can be provided if requested.

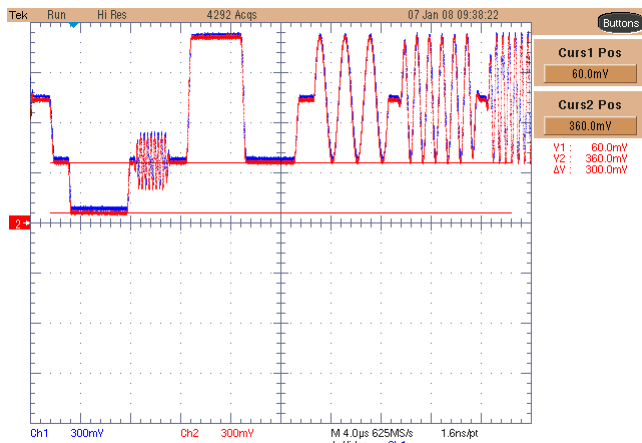


Figure 18. Multiburst Test with Two 150 Ω Loads

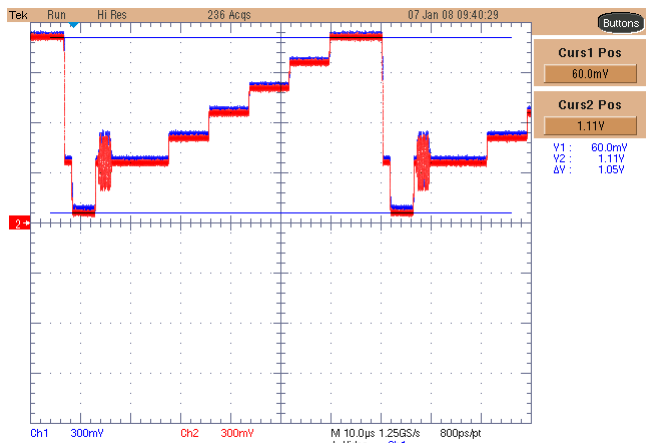
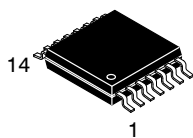


Figure 19. Linearity Test with Two 150 Ω Loads

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

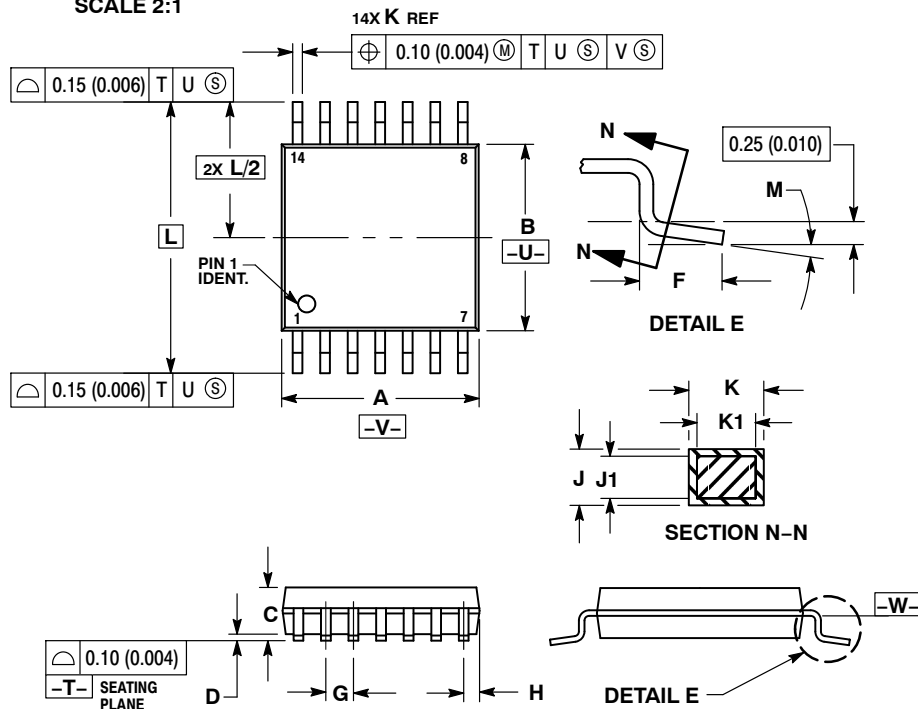
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SCALE 2:1

TSSOP-14 WB CASE 948G ISSUE C

DATE 17 FEB 2016

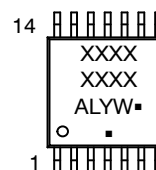


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

GENERIC MARKING DIAGRAM*

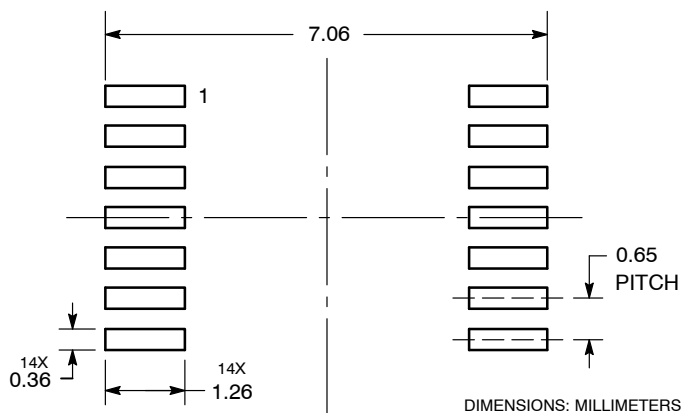


- A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

SOLDERING FOOTPRINT



DOCUMENT NUMBER: 98ASH70246A

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DESCRIPTION: TSSOP-14 WB

PAGE 1 OF 1

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